



Date: 07/27/2023

ENV-00308 Rev H
Certificate of Compliance:
ISO 9001 Design, Marketing and Sales of Machine-to-Machine Connectivity Hardware and Software,
RoHS and REACH: SVHC

Lantronix Part Numbers:
QC-DB-J10003, QC-DB-J10004 (Open-Q™ 2500)
QC-DB-K10003D, QC-DB-K10004D (Open-Q™ 212A)
QC-DB-I10003, QC-DB-I10014 (Open-Q™ 820)
QC-DB-H00003, QC-DB-H00004, QC-DB-H00005 (Open-Q™ 410)
QC-DB-M10023A, QC-DB-J00005, QC-DB-M10032 (Open-Q™ 624A)
QC-DB-M00003, QC-DB-M00004 (Open-Q™ 626)
QC-DB-N10003, QC-DB-N10004 (Open-Q™ 660)
QC-DB-I20003, QC-DB-I20004 (Open-Q™ 820Pro)
QC-DB-P10003, QC-DB-P10004, QC-DB-P10004A (Open-Q™ 845)
QC-DB-U00003, QC-DB-U00005, QC-DB-U00007, (Snapdragon™ 865 Mobile HDK)
QC-HDK-8550, QC-HDK-8550-D, QC-HDK-8550-R, QC-HDK-8550-S (Snapdragon™ 8 Gen 2 Mobile Hardware Development Kit)
QC-HDK-8450, QC-HDK-8450-D, QC-HDK-8450-R, QC-HDK-8450-S, QC-HDK-8450-B, QC-HDK-8450-B-KIT (Snapdragon™ 8 Gen 1 Mobile Hardware Development Kit)
QC-DB-W00003, QC-DB-W00006, QC-DB-U00007 (Snapdragon™ 888 Mobile Hardware Development Kit)
QC-DB-R00003_1, QC-DB-P00006, QC-DB-P00007 (Snapdragon™ 670 Mobile Hardware Development Kit)
QC-DB-P00005, QC-DB-P00006, QC-DB-P00007 (Snapdragon™ 845 Mobile HDK)
QC-DB-T00003, QC-DB-T00005 (Snapdragon™ 855 Mobile HDK)
QC-DB-C00003, QC-DB-B00004 (DragonBoard 800 Development Kit)

The above-captioned products (the “Products”) are manufactured by an ISO 9001 certificated supplier. The Products conform to the specifications in the applicable Lantronix Data Sheet for each of these part numbers.

Lantronix, Inc. (“Lantronix”) is committed to marketing environmentally friendly products. Lantronix expects its contract manufacturers and their suppliers to ensure that material, components, and processes comply with the appropriate directive regarding usage of hazardous substances. To the best of Lantronix’s knowledge, all



materials, components, and processes used in the manufacture of the Product are in compliance with the following:

- 1) 2011/65/EU Restriction of the use of Hazardous Substances in EEE (RoHS).
- 2) 2015/863/EU Change of Annex II from 2011/65/EU.
- 3) Exemptions listed in the Annex III (Directive (EU) 2018/736 & 2018/742 & 2019/172).
- 4) REACH: REGULATION (EC) No 1907/2006.
- 5) The above-captioned products (the "Products") do not contain more than 0.1 % of product weight for each of 235 substances which are announced by ECHA as "Substances of Very High Concern (SVHC)". SVHC is defined in Article 59(10) of REACH regulations, based on the most recent substances. [235 Substances, last update: June 14, 2023] (Reference URL: <https://echa.europa.eu/candidate-list-table>).
- 6) Regarding the requirement of Article 67 of REACH: A substance on its own, in a preparation or in an article, for which Annex XVII contains a restriction shall not be manufactured, placed on the market, or used unless it complies with the conditions of that restriction. We declare that none of the substances in the Conditions of restriction is present in Lantronix's products (and package also).
- 7) In addition of SVHC substances into Annex XIV and the addition of restricted substances in Annex XVII, Lantronix will evaluate any further revision in time and update this declaration to reflect these changes.
- 8) Chip Resistor that contains Lead oxide (PbO, CAS No. 1317-36-8) in raw materials, after a high-temperature process, PbO and multiple constituents merge into glass, which is out of SVHC scope. Please refer to the JEITA's explanation.

Dongping Qi
Environmental Engineer
Worldwide Supplier Quality
Lantronix, Inc.